
OX-220

Features

- Reflow Process Compatible
- Surface Mount package
- SC_CUT Crystal
- Low Profile Compact Package (8.3mm)
- Standard Frequencies: 10; 12.8; 19.2; 20; 26; 30.72 Mhz

Applications

- Base stations
- Test equipment
- Synthesizers
- Military communication equipment
- Digital Switching

Performance Specifications

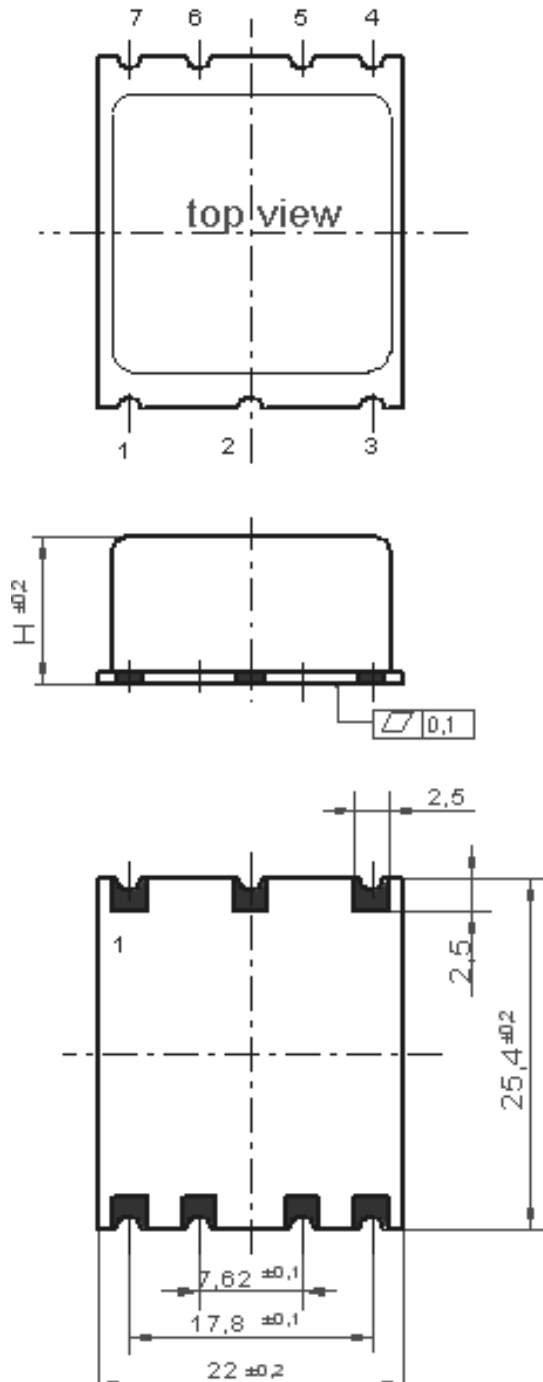
Frequency Stabilities ¹ (SC-Cut Crystal-Option - 10 to 40 MHz)					
Parameter	Min	Typical	Max	Units	Condition
vs. operating temperature range (referenced to +25°C)	-10 -10		+10 +10	ppb ppb	-20 to +70°C -40 to +85°C
Initial tolerance	-0.2		+0.2	ppm	at time of shipment, nominal EFC
vs. supply voltage change	-5		+5	ppb	V _s ±5% static
vs. load change	-5		+5	ppb	Load ±5% static
vs. aging / day	-0.5		+0.5	ppb	≤10 Mhz after 30 days of operation
vs. aging / day	-1		+1	ppb	> 10 Mhz after 30 days of operation
vs. aging / year	-60		+60	ppb	≤ 10 Mhz after 30 days of operation
vs. aging / year	-100		+100	ppb	> 10 Mhz after 30 days of operation
Holdover					
start up time					
Warm-up time			5	minutes	to ±100ppb of final frequency (1 hour reading) @ +25°C

Performance Specifications

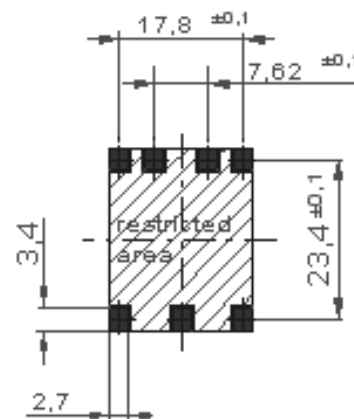
Supply Voltage (Vs)					
Parameter	Min	Typical	Max	Units	Condition
Supply voltage (standard)	3.135	3.3	3.465	VDC	
	4.75	5.0	5.25	VDC	
Power consumption			3.1	Watts	during warm-up
			1.5	Watts	steady state @ +25°C
RF Output					
Signal [standard]	HCMOS				
Load		15		pF	
Signal Level (Vol)			0.4	VDC	with Vs=3.3V and 15pF Load
Signal Level (Vol)			0.5		with Vs=5.0V & 12V and 15pF Load
Signal Level (Voh)	2.4			VDC	with Vs=3.3V and 15pF Load
Signal Level (Voh)	3.5				with Vs=5.0V & 12V and 15pF Load
Duty Cycle	45		55	%	@ (Voh-Vol)/2
Rise time			5	ns	
Fall time			5	ns	
Signal	Sine Wave				
Load		50		Ω	
Output Power @3,3V	2	5	8	dBm	50 Ω load
Output Power @ 5.0V	5	8	11	dBm	50 Ω load
Harmonics			-30	dBm	50 Ω load
Frequency Tuning (EFC)					
Tuning Range	Fixed OCXO; No adjust				Opti-on ⁵
	±0.8		±2.4	ppm	
Linearity	10%				with SC cut crystal
Tuning Slope	Positive				
Control Voltage Range	0.0	1.4	2.8	VDC	with Vs=3.3V
	0.0	2.0	4.0	VDC	with Vs=5.0V
modulation					
Reference Voltage Output (Vref)					
Reference Voltage	2.75	2.8	2.85	VDC	with Vs = 3.3 VDC
	3.92	4.0	4.08	VDC	with Vs = 5.0 VDC
Additional Parameters					
Phase Noise ³		-80	-70	dBc/Hz	1 Hz
		-110	-105	dBc/Hz	10 Hz
		-138	-130	dBc/Hz	100 Hz
		-148	-140	dBc/Hz	1 kHz
		-152	-145	dBc/Hz	10 kHz
Phase Noise ³		-90	-80	dBc/Hz	1 Hz
		-120	-110	dBc/Hz	10 Hz
		-140	-135	dBc/Hz	100 Hz
		-148	-145	dBc/Hz	1 kHz
		-152	-145	dBc/Hz	10 kHz
Weight			10	g	
Processing & Packing	Handling & Processing Note				

Absolute Maximum Ratings					
supply voltage (Vs)			5.5	V	with Vs=3.3 & 5.0 VDC
Output Load			50	pF	
Operable Temperature Range	-45		+85	°C	
Storage Temperature Range	-45		+85	°C	

Outline Drawing / Enclosure



OX-220	
Height "H"	cover material
12.1	plastic
8.5	plastic

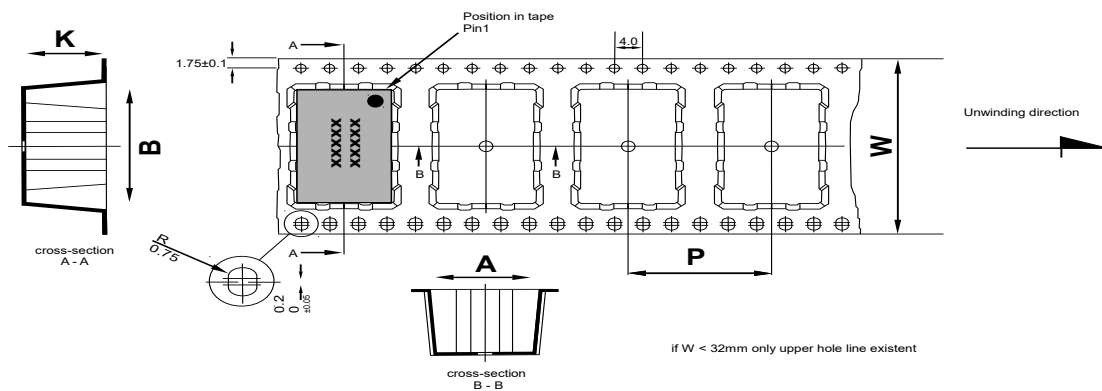


Padvorschlag
land pattern
recommendation

Pin Connections	
1	Electronic Frequency Control Input (EFC)
2	Reference Voltage output
3	Supply Voltage Input (Vs)
4	RF Output
5	Oven Alarm
6	N.C or Option (must remain un connected)
7	Ground (Case)

Dimensions in mm

Standard Shipping Method (OX-220 / OX -221)



Dimension in mm:

A, B and K are dependent upon component dimensions
production tolerance complying DIN IEC 286-3

All dimensions in millimeters unless otherwise stated

Enclosure Type	Tape Width W (mm)	Quantity per meter	Quantity per reel	Dimension P
OX-2201 (12.1mm)	44	37.5	175	28
OX-2206 (8.5mm)	44	37.5	250	28

Recommended Reflow Profile

IPC/JEDEC J-STD-020 (latest revision)

Additional Information:

This SMD oscillator has been designed for pick and place reflow soldering.

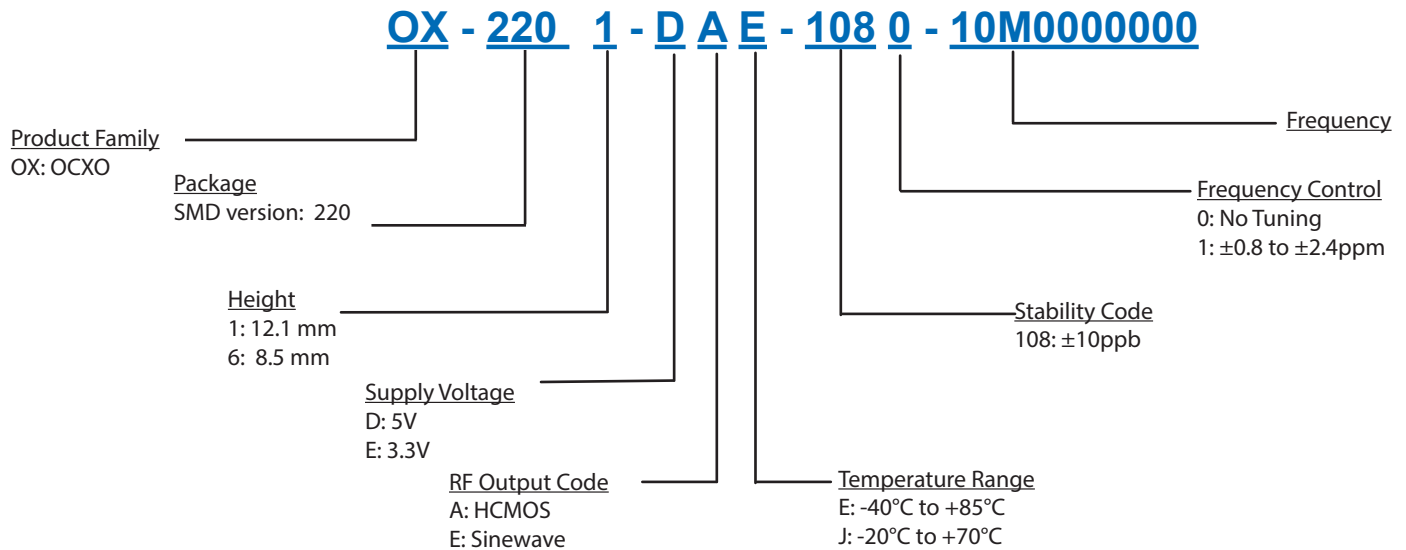
SMD oscillators must be on the top side of the PCB during the reflow process.

Additional Environmental Conditions

Parameter	Description
Rapid temperature changes	MIL-883-1010 Cond B 1000 cycles -55/125C
Vibration	MIL-STD-883 Meth 2007 Cond A 20G 20-2000Hz 4x in each 3axis 4 min
Shock	Mech.Shock MIL-STD-202 Meth 213 Cond.C 100G 6ms 6 shocks in each direction
Solderability	J_STD_002C Cond A, Through hole device/ Cond. B, SMD 255C (diving time 50,5sec.) Dip+Look with 8h damp pre-treatment: solder wetting >95%
Solvent resistance	MIL-STD-883 Meth 2015 Solv. 1,3,4
ESD	HBM JESD22-A114-F Class 1C 10* 1000V
Moisture Sensit.	Level 1 JESD22-A113-B
RoHS compliance	100% RoHS 6 compliant
Washable	non-washable device

Note: All temperatures refer to topside of the package, measured on the package body surface.

Ordering Information



Notes:

1. Contact factory for improved stabilities or additional product options. Not all options and codes are available at all frequencies.
2. Unless other stated all values are valid after warm-up time and refer to typical conditions for supply voltage, frequency control voltage, load, temperature (25°C).
3. Phase noise degrades with increasing output frequency.
4. Subject to technical modification.
5. Contact factory for availability.

Contact Information

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